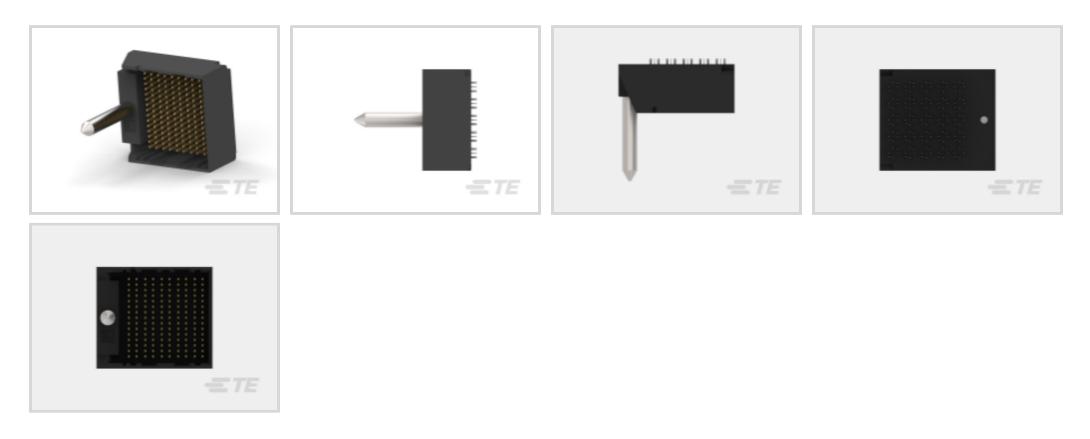


IMPACT

TE Internal #: 2143558-2 High Speed Backplane Connectors, 150 Position, Mating Alignment, Guide Pin Mating Alignment Type, 15 Row, 10 Column, PCB Mount Header, IMPACT

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Connectors > PCB Connectors > Backplane Connectors > High Speed Backplane Connectors



Connector System: Board-to-Board Number of Positions: 150 Row-to-Row Spacing: 1.15 mm [.045 in] Mating Alignment: With

Mating Alignment Type: Guide Pin

Features

connectivity

Product Type Features

Signal Arrangement	Differential
Connector System	Board-to-Board
PCB Connector Assembly Type	PCB Mount Header
Shroud Style	Fully Shrouded
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Ground Positions	50
Number of Pairs	50
Stackable	No
Number of Signal Positions	100
Backplane Architecture	Orthogonal
Number of Positions	150
Number of Rows	15
Number of Columns	10

High Speed Backplane Connectors, 150 Position, Mating Alignment, Guide Pin Mating Alignment Type, 15 Row, 10 Column, PCB Mount Header, IMPACT



PCB Mount Orientation	Vertical
Guide Location	Left
Electrical Characteristics	
Impedance	100 Ω
Operating Voltage	30 VAC
Signal Characteristics	
Number of Differential Pairs per Column	5
Data Rate	20 – 25 Gb/s
Body Features	
Primary Product Color	Black
Contact Features	
Contact Mating Area Length	5.5 mm[.217 in]
PCB Contact Termination Area Plating Material Thickness	.76 – 1.52 μm[30 – 60 μin]
Contact Layout	Inline
Contact Type	Pin
Contact Underplating Material Thickness	1.27 μm[50 μin]
Contact Mating Area Plating Material Thickness	.76 μm[29.92 μin]
Contact Mating Area Plating Material	Gold
PCB Contact Termination Area Plating Material Finish	Matte
Contact Shape & Form	Dual Beam
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Alloy
Contact Current Rating (Max)	.75 A
Termination Features	
Termination Post & Tail Length	1.4 mm[.055 in]
Termination Method to Printed Circuit Board	Through Hole - Press-Fit
Mechanical Attachment	
PCB Mount Alignment Type	Locating Posts
Guide Hardware	With
Mating Retention	Without
PCB Mount Retention	With

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PCB Mount Retention Type	Action/Compliant Tail & Screw
Mating Alignment	With
Mating Alignment Type	Guide Pin
Connector Mounting Type	Board Mount
Housing Features	
Number of Shrouded Sides	3
End Wall Location	Right
Housing Material	LCP (Liquid Crystal Polymer)
Centerline (Pitch)	1.9 mm[.075 in]
Dimensions	
Connector Length	28.4 mm[1.118 in]
Connector Height	11.95 mm[.47 in]
Connector Width	24.8 mm[.976 in]
PCB Thickness (Recommended)	3 mm[1.118 in]
PCB Hole Diameter	.39 mm[.015 in]
Row-to-Row Spacing	1.15 mm[.045 in]
Usage Conditions	

Operating	Temperature	Range

-55 – 85 °C[-67 – 185 °F]

Operation/Application

Circuit Application	Signal
Industry Standards	
Approved Standards	CSA Certified, UL E28476
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Method	Box & Tube, Package
Product Compliance	
For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	

High Speed Backplane Connectors, 150 Position, Mating Alignment, Guide Pin Mating Alignment Type, 15 Row, 10 Column, PCB Mount Header, IMPACT



Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Halogen Content

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

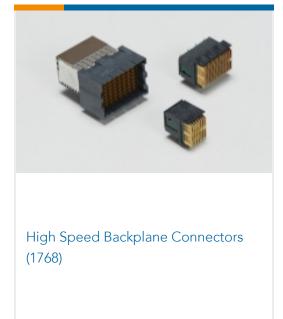
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



TE Part # 2132695-1 IMP100O,R,RA5P10C,UG,39

Also in the Series | IMPACT

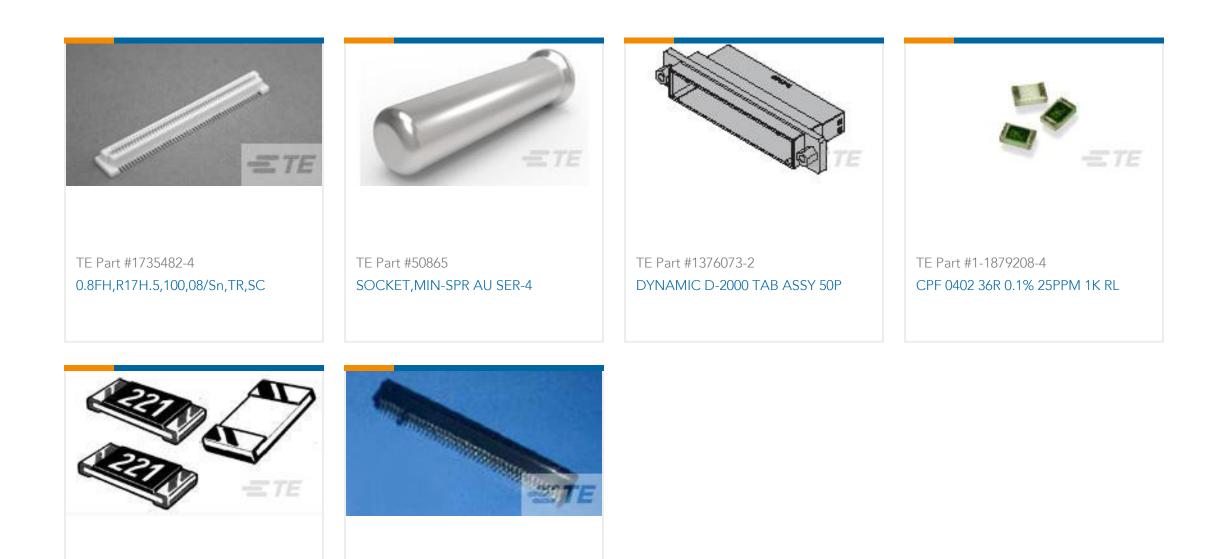


Customers Also Bought

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Documents

TE Part #4-2176230-7

3522 5K6 5% 3W

Product Drawings IMP100O,HMP,V5P10C,LG,REW39,5.5

TE Part #9-1734774-3

PCI EXP 2.3L 64 POS BLK 30u"

English

CAD Files

3D PDF

3D

Customer View Model ENG_CVM_CVM_2143558-2_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2143558-2_D.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2143558-2_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English

Agency Approvals Agency Approval Document

English